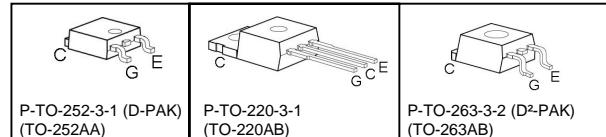
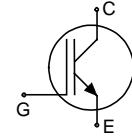


### Fast IGBT in NPT-technology

- 75% lower  $E_{off}$  compared to previous generation combined with low conduction losses
- Short circuit withstand time – 10  $\mu\text{s}$
- Designed for:
  - Motor controls
  - Inverter
- NPT-Technology for 600V applications offers:
  - very tight parameter distribution
  - high ruggedness, temperature stable behaviour
  - parallel switching capability



- Complete product spectrum and PSpice Models : <http://www.infineon.com/igbt/>

| Type     | $V_{CE}$ | $I_C$ | $V_{CE(\text{sat})}$ | $T_j$ | Package        | Ordering Code |
|----------|----------|-------|----------------------|-------|----------------|---------------|
| SGP02N60 | 600V     | 2A    | 2.2V                 | 150°C | TO-220AB       | Q67040-S4504  |
| SGB02N60 |          |       |                      |       | TO-263AB       | Q67040-S4505  |
| SGD02N60 |          |       |                      |       | TO-252AA(DPAK) | Q67041-A4707  |

### Maximum Ratings

| Parameter  | Symbol             | Value      | Unit             |
|--|--------------------|------------|------------------|
| Collector-emitter voltage  | $V_{CE}$           | 600        | V                |
| DC collector current   | $I_C$              | 6.0<br>2.9 | A                |
| $T_C = 25^\circ\text{C}$   |                    |            |                  |
| $T_C = 100^\circ\text{C}$  |                    |            |                  |
| Pulsed collector current, $t_p$ limited by $T_{j\text{max}}$   | $I_{C\text{puls}}$ | 12         |                  |
| Turn off safe operating area   | -                  | 12         |                  |
| $V_{CE} \leq 600\text{V}, T_j \leq 150^\circ\text{C}$  |                    |            |                  |
| Gate-emitter voltage   | $V_{GE}$           | $\pm 20$   | V                |
| Avalanche energy, single pulse   | $E_{AS}$           | 13         | mJ               |
| $I_C = 2\text{ A}, V_{CC} = 50\text{ V}, R_{GE} = 25\Omega$ ,<br>start at $T_j = 25^\circ\text{C}$                       |                    |            |                  |
| Short circuit withstand time <sup>1)</sup><br>$V_{GE} = 15\text{V}, V_{CC} \leq 600\text{V}, T_j \leq 150^\circ\text{C}$ | $t_{SC}$           | 10         | $\mu\text{s}$    |
| Power dissipation  | $P_{tot}$          | 30         | W                |
| $T_C = 25^\circ\text{C}$   |                    |            |                  |
| Operating junction and storage temperature   | $T_j, T_{stg}$     | -55...+150 | $^\circ\text{C}$ |

<sup>1)</sup> Allowed number of short circuits: <1000; time between short circuits: >1s.

**Thermal Resistance**

| Parameter                                | Symbol     | Conditions           | Max. Value |  | Unit |
|--|------------|----------------------|------------|--|------|
| <b>Characteristic</b>                    |            |                      |            |  |      |
| IGBT thermal resistance, junction – case | $R_{thJC}$ |                      | 4.2        |  | K/W  |
| Thermal resistance, junction – ambient   | $R_{thJA}$ | TO-220AB             | 62         |  |      |
| SMD version, device on PCB <sup>1)</sup> | $R_{thJA}$ | TO-252AA<br>TO-263AB | 50<br>40   |  |      |

**Electrical Characteristic**, at  $T_j = 25^\circ\text{C}$ , unless otherwise specified

| Parameter | Symbol | Conditions | Value |      |      | Unit |
|-----------|--------|------------|-------|------|------|------|
|           |        |            | min.  | Typ. | max. |      |

**Static Characteristic**

|                                      |                      |   |          |            |            |               |
|--------------------------------------|----------------------|---|----------|------------|------------|---------------|
| Collector-emitter breakdown voltage  | $V_{(BR)CES}$        | $V_{GE}=0\text{V}, I_C=500\mu\text{A}$  | 600      | -          | -          | V             |
| Collector-emitter saturation voltage | $V_{CE(\text{sat})}$ | $V_{GE} = 15\text{V}, I_C=2\text{A}$<br>$T_j=25^\circ\text{C}$<br>$T_j=150^\circ\text{C}$   | 1.7<br>- | 1.9<br>2.2 | 2.4<br>2.7 |               |
| Gate-emitter threshold voltage       | $V_{GE(\text{th})}$  | $I_C=150\mu\text{A}, V_{CE}=V_{GE}$   | 3        | 4          | 5          |               |
| Zero gate voltage collector current  | $I_{CES}$            | $V_{CE}=600\text{V}, V_{GE}=0\text{V}$<br>$T_j=25^\circ\text{C}$<br>$T_j=150^\circ\text{C}$ | -<br>-   | -<br>-     | 20<br>250  | $\mu\text{A}$ |
| Gate-emitter leakage current         | $I_{GES}$            | $V_{CE}=0\text{V}, V_{GE}=20\text{V}$   | -        | -          | 100        | nA            |
| Transconductance                     | $g_{fs}$             | $V_{CE}=20\text{V}, I_C=2\text{A}$  | -        | 1.6        | -          | S             |

**Dynamic Characteristic**

|  |                    |   |   |     |     |    |
|--|--------------------|---|---|-----|-----|----|
| Input capacitance  | $C_{iss}$          | $V_{CE}=25\text{V},$  | - | 142 | 170 | pF |
| Output capacitance   | $C_{oss}$          | $V_{GE}=0\text{V},$   | - | 18  | 22  |    |
| Reverse transfer capacitance                                   | $C_{rss}$          | $f=1\text{MHz}$   | - | 10  | 12  |    |
| Gate charge  | $Q_{\text{Gate}}$  | $V_{CC}=480\text{V}, I_C=2\text{A}$<br>$V_{GE}=15\text{V}$  | - | 14  | 18  | nC |
| Internal emitter inductance measured 5mm (0.197 in.) from case | $L_E$              | TO-220AB  | - | 7   | -   | nH |
| Short circuit collector current <sup>2)</sup>                  | $I_{C(\text{SC})}$ | $V_{GE}=15\text{V}, t_{sc}\leq 10\mu\text{s}$<br>$V_{CC} \leq 600\text{V},$<br>$T_j \leq 150^\circ\text{C}$ | - | 20  | -   | A  |

<sup>1)</sup> Device on 50mm\*50mm\*1.5mm epoxy PCB FR4 with 6cm<sup>2</sup> (one layer, 70μm thick) copper area for collector connection. PCB is vertical without blown air.

<sup>2)</sup> Allowed number of short circuits: <1000; time between short circuits: >1s.



SGP02N60,

SGB02N60

SGD02N60

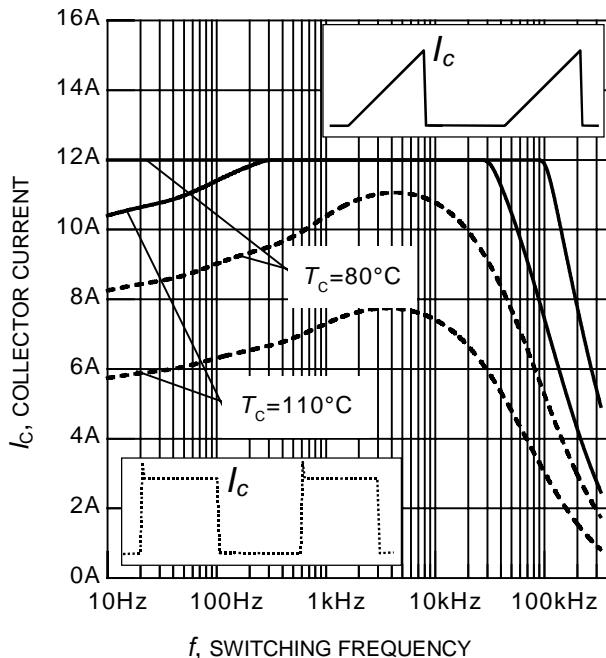
**Switching Characteristic, Inductive Load, at  $T_j=25^\circ\text{C}$**

| Parameter                  | Symbol       | Conditions   | Value |       |       | Unit |
|----------------------------|--------------|--|-------|-------|-------|------|
|                            |              |  | min.  | typ.  | max.  |      |
| <b>IGBT Characteristic</b> |              |  |       |       |       |      |
| Turn-on delay time         | $t_{d(on)}$  | $T_j=25^\circ\text{C}$ ,<br>$V_{CC}=400\text{V}$ , $I_C=2\text{A}$ ,<br>$V_{GE}=0/15\text{V}$ ,<br>$R_G=118\Omega$ ,<br>$L_\sigma^{(1)}=180\text{nH}$ ,<br>$C_\sigma^{(1)}=180\text{pF}$<br>Energy losses include<br>“tail” and diode<br>reverse recovery. | -     | 20    | 24    | ns   |
| Rise time                  | $t_r$        |  | -     | 13    | 16    |      |
| Turn-off delay time        | $t_{d(off)}$ |  | -     | 259   | 311   |      |
| Fall time                  | $t_f$        |  | -     | 52    | 62    |      |
| Turn-on energy             | $E_{on}$     |  | -     | 0.036 | 0.041 | mJ   |
| Turn-off energy            | $E_{off}$    |  | -     | 0.028 | 0.036 |      |
| Total switching energy     | $E_{ts}$     |  | -     | 0.064 | 0.078 |      |

**Switching Characteristic, Inductive Load, at  $T_j=150^\circ\text{C}$**

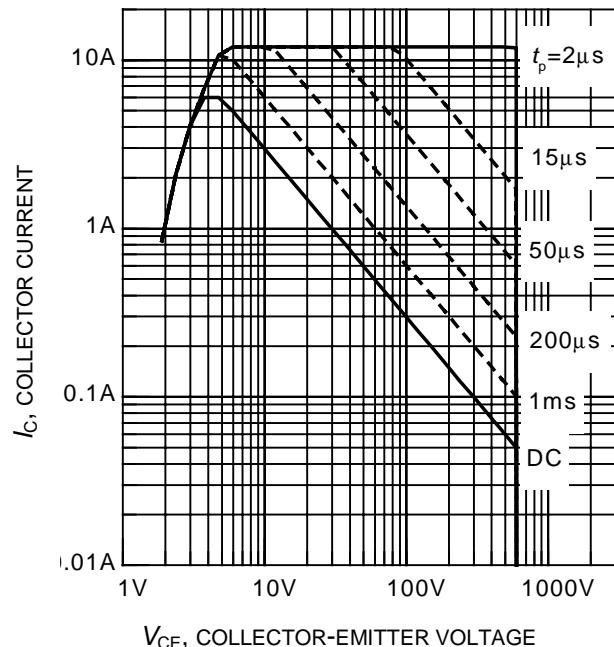
| Parameter                  | Symbol       | Conditions  | Value |       |       | Unit |
|----------------------------|--------------|---|-------|-------|-------|------|
|                            |              |   | min.  | typ.  | max.  |      |
| <b>IGBT Characteristic</b> |              |   |       |       |       |      |
| Turn-on delay time         | $t_{d(on)}$  | $T_j=150^\circ\text{C}$ ,<br>$V_{CC}=400\text{V}$ , $I_C=2\text{A}$ ,<br>$V_{GE}=0/15\text{V}$ ,<br>$R_G=118\Omega$ ,<br>$L_\sigma^{(1)}=180\text{nH}$ ,<br>$C_\sigma^{(1)}=180\text{pF}$<br>Energy losses include<br>“tail” and diode<br>reverse recovery. | -     | 20    | 24    | ns   |
| Rise time                  | $t_r$        |   | -     | 14    | 17    |      |
| Turn-off delay time        | $t_{d(off)}$ |   | -     | 287   | 344   |      |
| Fall time                  | $t_f$        |   | -     | 67    | 80    |      |
| Turn-on energy             | $E_{on}$     |   | -     | 0.054 | 0.062 | mJ   |
| Turn-off energy            | $E_{off}$    |   | -     | 0.043 | 0.056 |      |
| Total switching energy     | $E_{ts}$     |   | -     | 0.097 | 0.118 |      |

<sup>1)</sup> Leakage inductance  $L_\sigma$  and Stray capacity  $C_\sigma$  due to dynamic test circuit in Figure E.



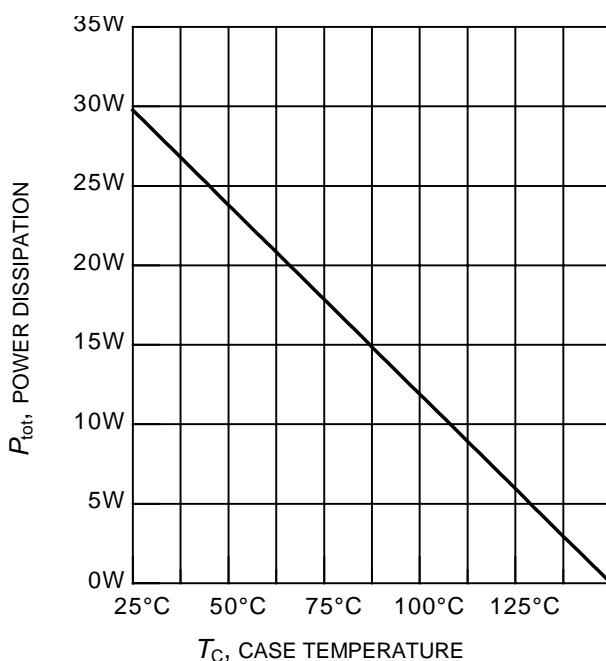
**Figure 1. Collector current as a function of switching frequency**

( $T_j \leq 150^\circ\text{C}$ ,  $D = 0.5$ ,  $V_{CE} = 400\text{V}$ ,  
 $V_{GE} = 0/+15\text{V}$ ,  $R_G = 118\Omega$ )



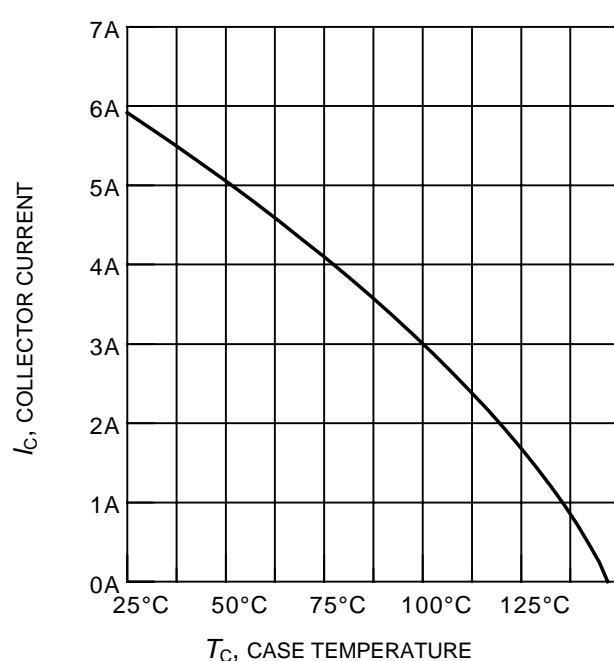
**Figure 2. Safe operating area**

( $D = 0$ ,  $T_c = 25^\circ\text{C}$ ,  $T_j \leq 150^\circ\text{C}$ )



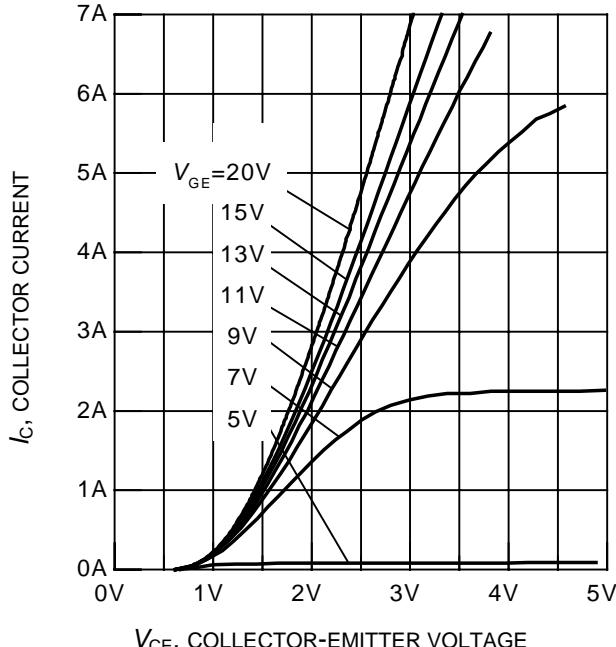
**Figure 3. Power dissipation (IGBT) as a function of case temperature**

( $T_j \leq 150^\circ\text{C}$ )

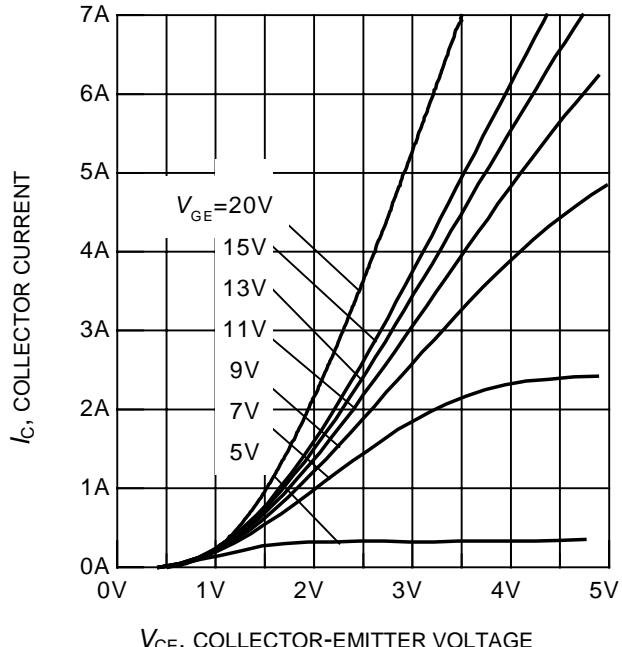


**Figure 4. Collector current as a function of case temperature**

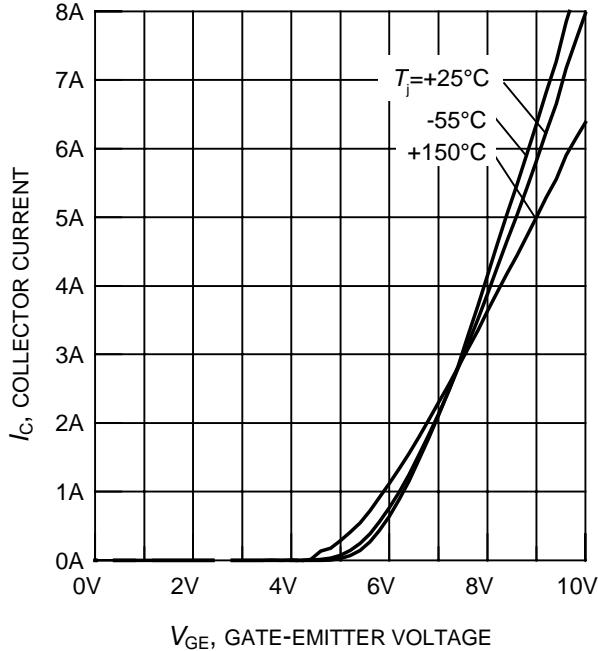
( $V_{GE} \leq 15\text{V}$ ,  $T_j \leq 150^\circ\text{C}$ )



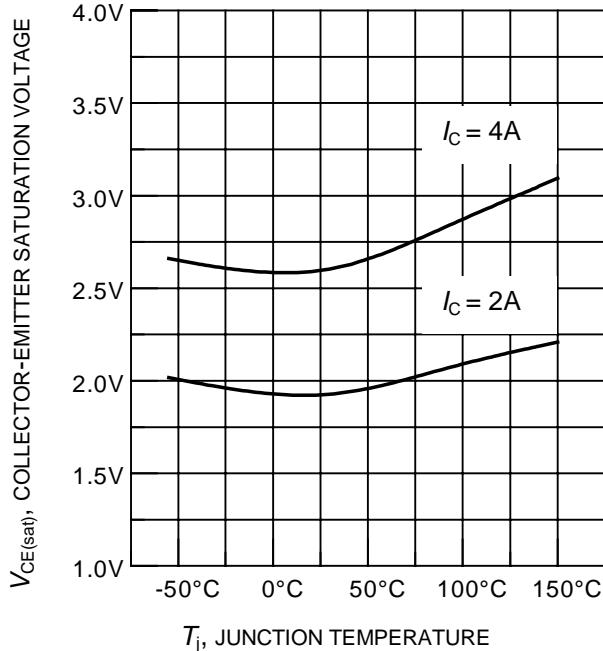
**Figure 5. Typical output characteristics**  
( $T_j = 25^\circ\text{C}$ )



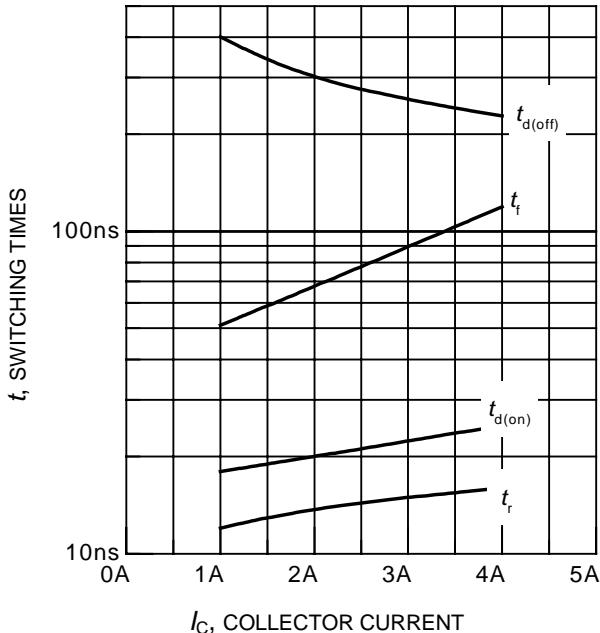
**Figure 6. Typical output characteristics**  
( $T_j = 150^\circ\text{C}$ )



**Figure 7. Typical transfer characteristics**  
( $V_{CE} = 10\text{V}$ )

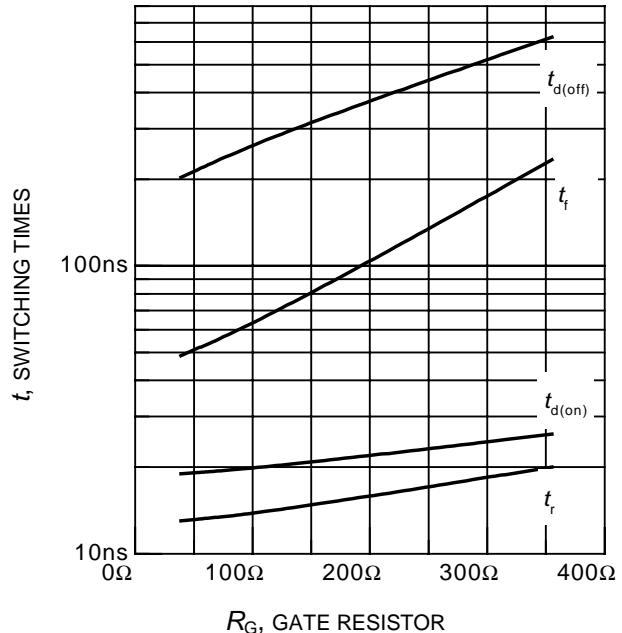


**Figure 8. Typical collector-emitter saturation voltage as a function of junction temperature**  
( $V_{GE} = 15\text{V}$ )



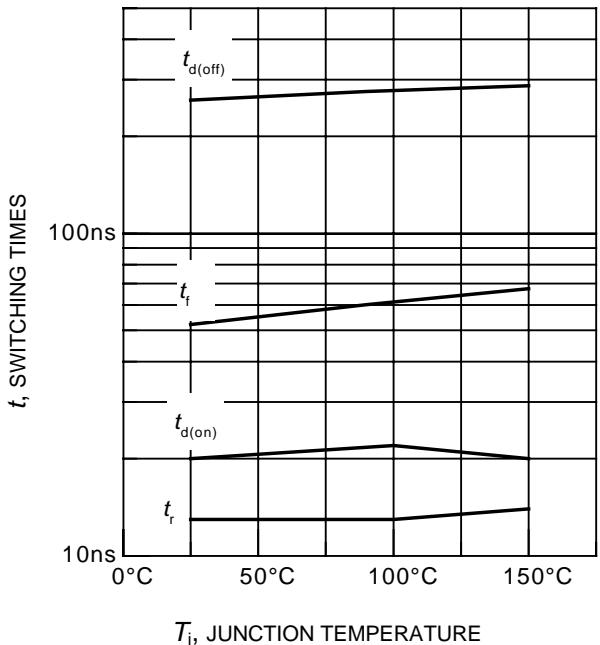
**Figure 9. Typical switching times as a function of collector current**

(inductive load,  $T_j = 150^\circ\text{C}$ ,  $V_{\text{CE}} = 400\text{V}$ ,  
 $V_{\text{GE}} = 0/+15\text{V}$ ,  $R_{\text{G}} = 118\Omega$ ,  
Dynamic test circuit in Figure E)



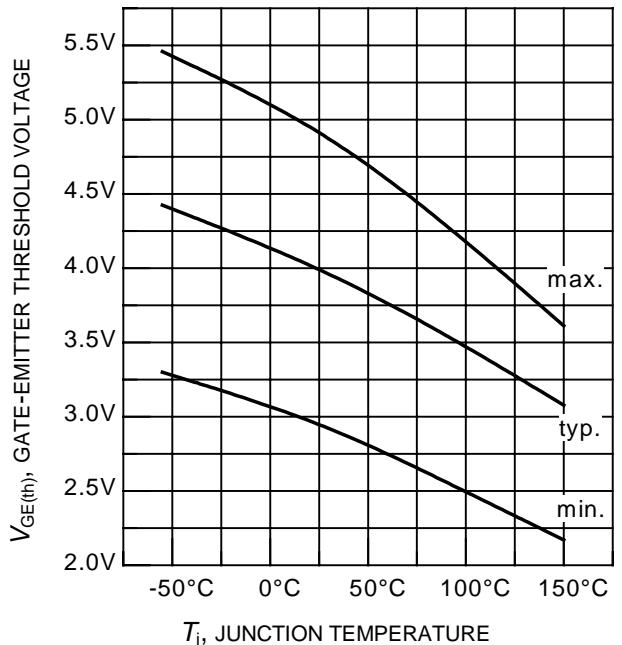
**Figure 10. Typical switching times as a function of gate resistor**

(inductive load,  $T_j = 150^\circ\text{C}$ ,  $V_{\text{CE}} = 400\text{V}$ ,  
 $V_{\text{GE}} = 0/+15\text{V}$ ,  $I_{\text{C}} = 2\text{A}$ ,  
Dynamic test circuit in Figure E)



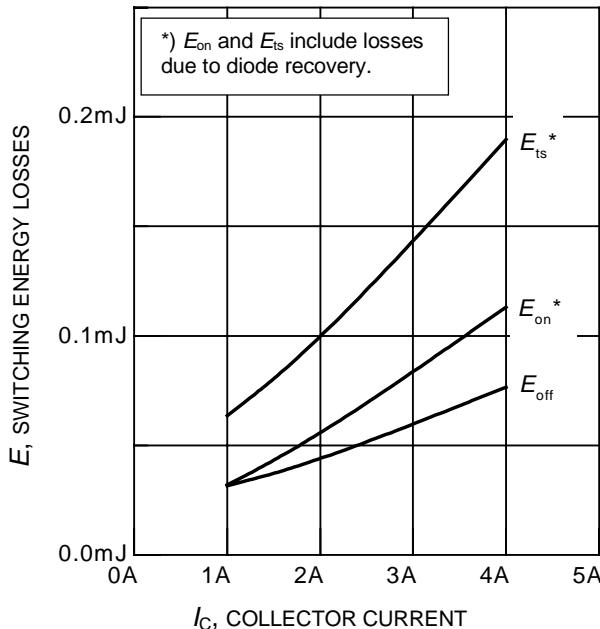
**Figure 11. Typical switching times as a function of junction temperature**

(inductive load,  $V_{\text{CE}} = 400\text{V}$ ,  $V_{\text{GE}} = 0/+15\text{V}$ ,  
 $I_{\text{C}} = 2\text{A}$ ,  $R_{\text{G}} = 118\Omega$ ,  
Dynamic test circuit in Figure E)



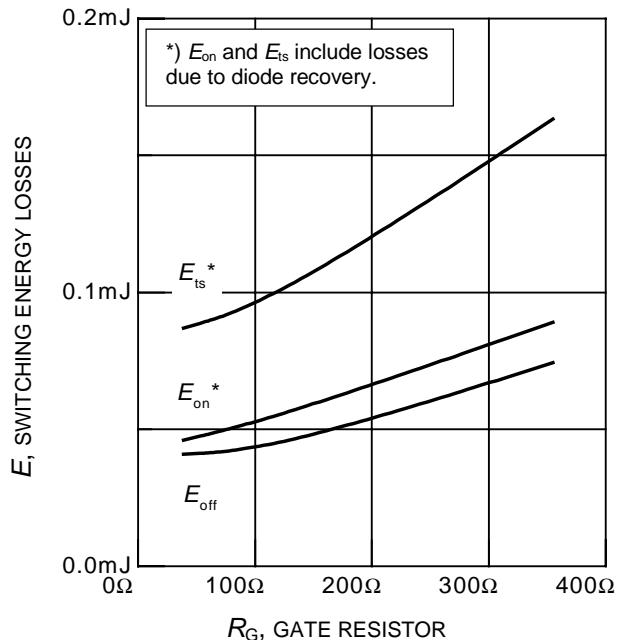
**Figure 12. Gate-emitter threshold voltage as a function of junction temperature**

( $I_{\text{C}} = 0.15\text{mA}$ )



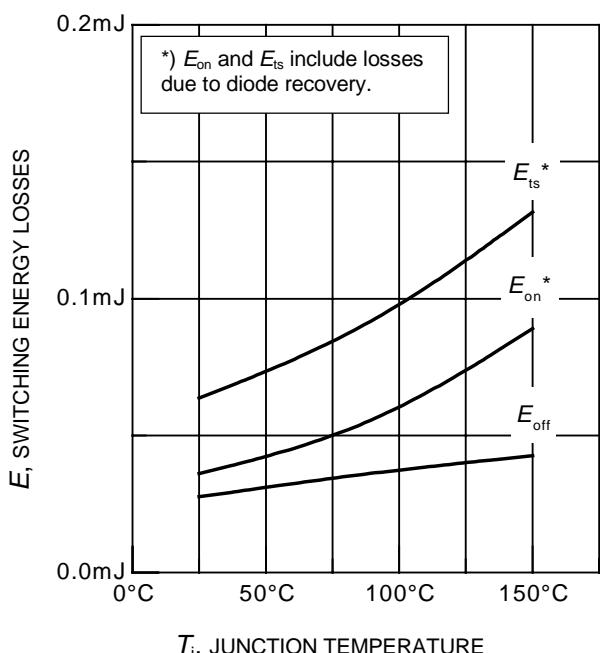
**Figure 13. Typical switching energy losses as a function of collector current**

(inductive load,  $T_j = 150^\circ\text{C}$ ,  $V_{CE} = 400\text{V}$ ,  
 $V_{GE} = 0/+15\text{V}$ ,  $R_G = 118\Omega$ ,  
Dynamic test circuit in Figure E)



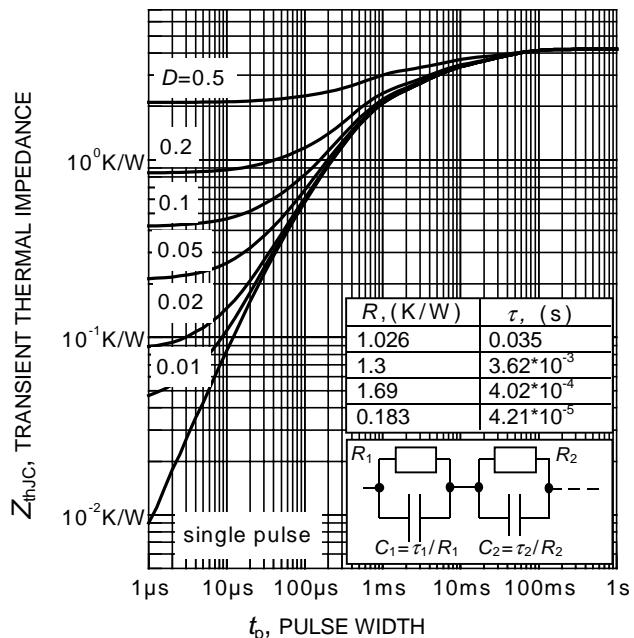
**Figure 14. Typical switching energy losses as a function of gate resistor**

(inductive load,  $T_j = 150^\circ\text{C}$ ,  $V_{CE} = 400\text{V}$ ,  
 $V_{GE} = 0/+15\text{V}$ ,  $I_C = 2\text{A}$ ,  
Dynamic test circuit in Figure E)



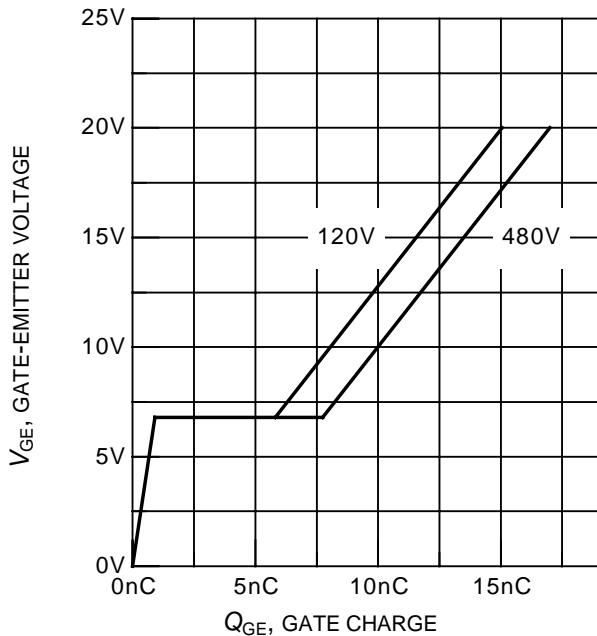
**Figure 15. Typical switching energy losses as a function of junction temperature**

(inductive load,  $V_{CE} = 400\text{V}$ ,  $V_{GE} = 0/+15\text{V}$ ,  
 $I_C = 2\text{A}$ ,  $R_G = 118\Omega$ ,  
Dynamic test circuit in Figure E)

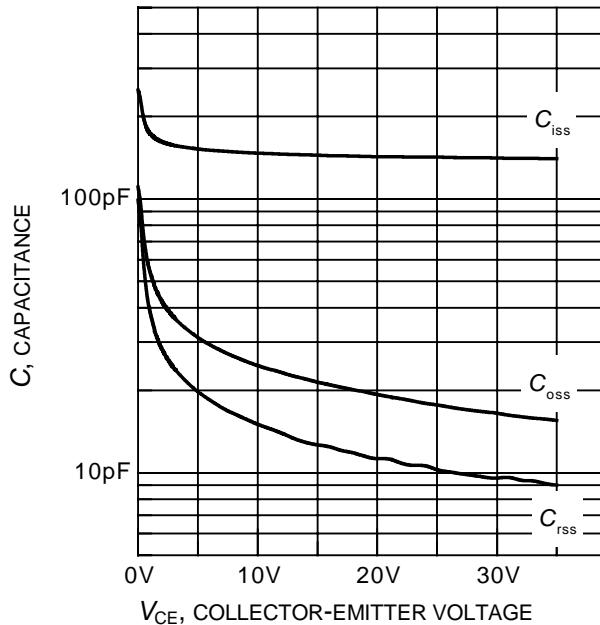


**Figure 16. IGBT transient thermal impedance as a function of pulse width**

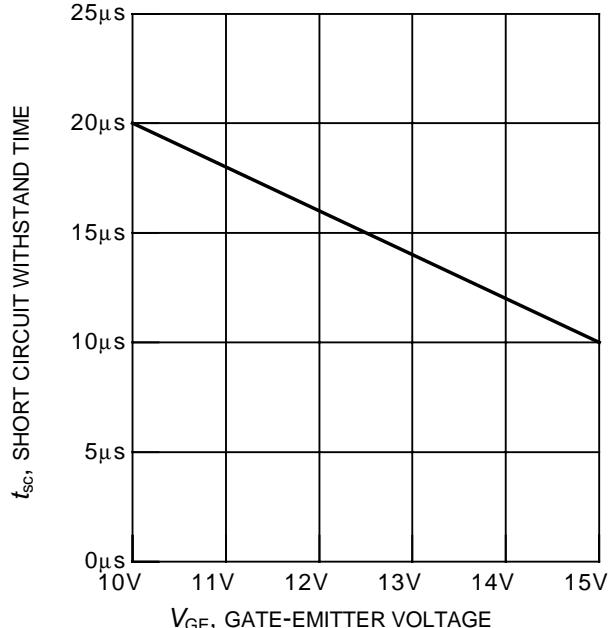
( $D = t_p / T$ )



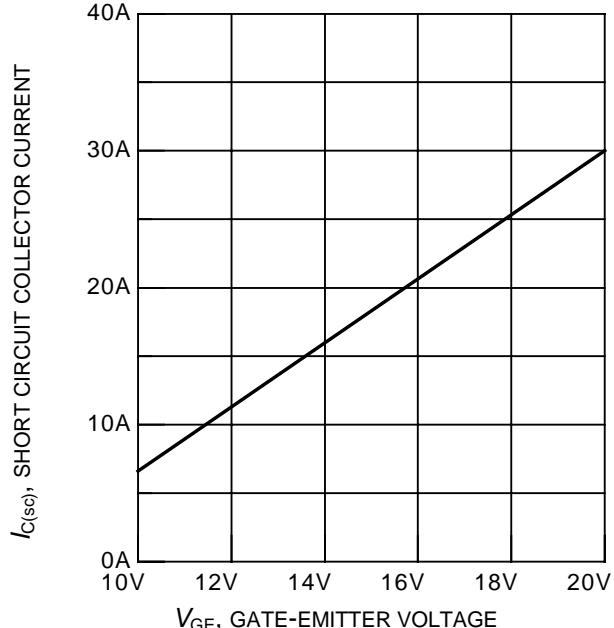
**Figure 17. Typical gate charge**  
 $(I_C = 2A)$



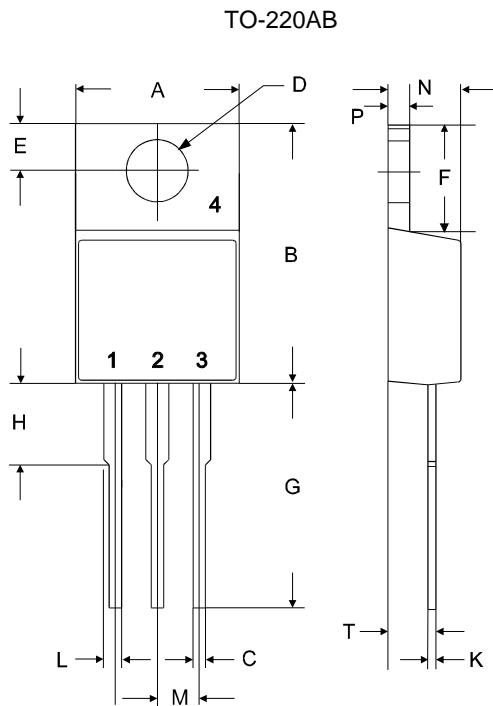
**Figure 18. Typical capacitance as a function of collector-emitter voltage**  
 $(V_{GE} = 0V, f = 1MHz)$



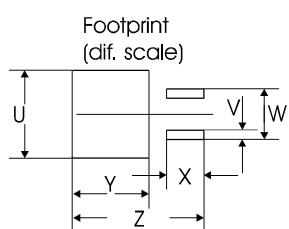
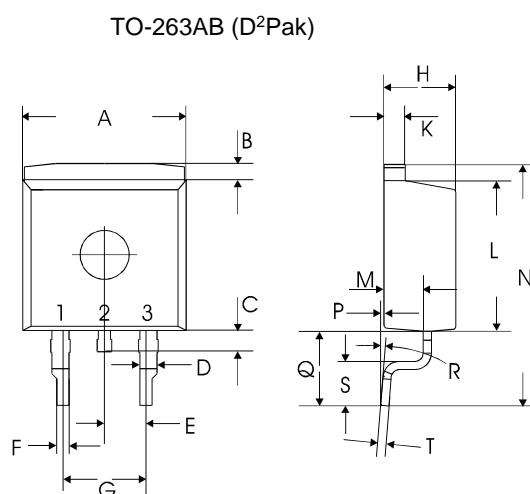
**Figure 19. Short circuit withstand time as a function of gate-emitter voltage**  
 $(V_{CE} = 600V, \text{start at } T_j = 25^\circ\text{C})$



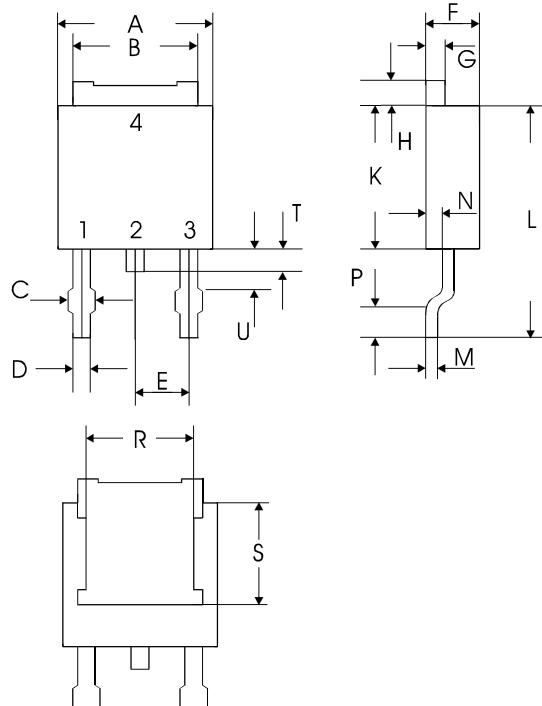
**Figure 20. Typical short circuit collector current as a function of gate-emitter voltage**  
 $(V_{CE} \leq 600V, T_j = 150^\circ\text{C})$



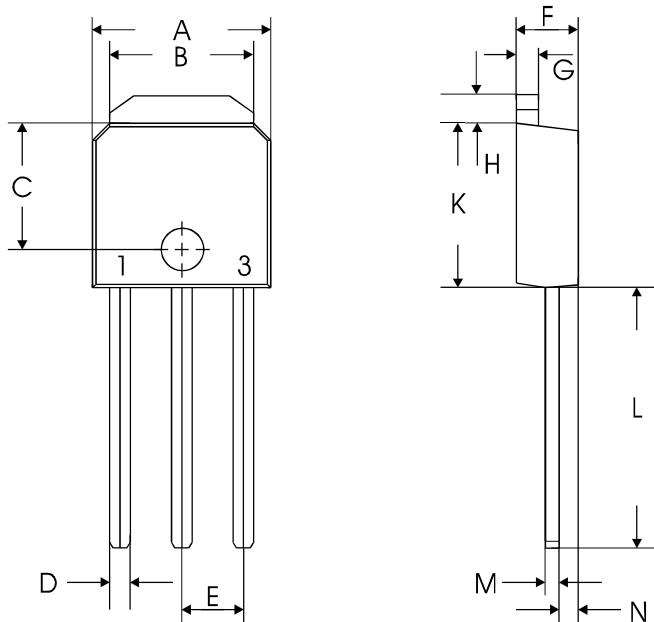
| symbol | dimensions |       |          |        |
|--------|------------|-------|----------|--------|
|        | [mm]       |       | [inch]   |        |
|        | min        | max   | min      | max    |
| A      | 9.70       | 10.30 | 0.3819   | 0.4055 |
| B      | 14.88      | 15.95 | 0.5858   | 0.6280 |
| C      | 0.65       | 0.86  | 0.0256   | 0.0339 |
| D      | 3.55       | 3.89  | 0.1398   | 0.1531 |
| E      | 2.60       | 3.00  | 0.1024   | 0.1181 |
| F      | 6.00       | 6.80  | 0.2362   | 0.2677 |
| G      | 13.00      | 14.00 | 0.5118   | 0.5512 |
| H      | 4.35       | 4.75  | 0.1713   | 0.1870 |
| K      | 0.38       | 0.65  | 0.0150   | 0.0256 |
| L      | 0.95       | 1.32  | 0.0374   | 0.0520 |
| M      | 2.54 typ.  |       | 0.1 typ. |        |
| N      | 4.30       | 4.50  | 0.1693   | 0.1772 |
| P      | 1.17       | 1.40  | 0.0461   | 0.0551 |
| T      | 2.30       | 2.72  | 0.0906   | 0.1071 |



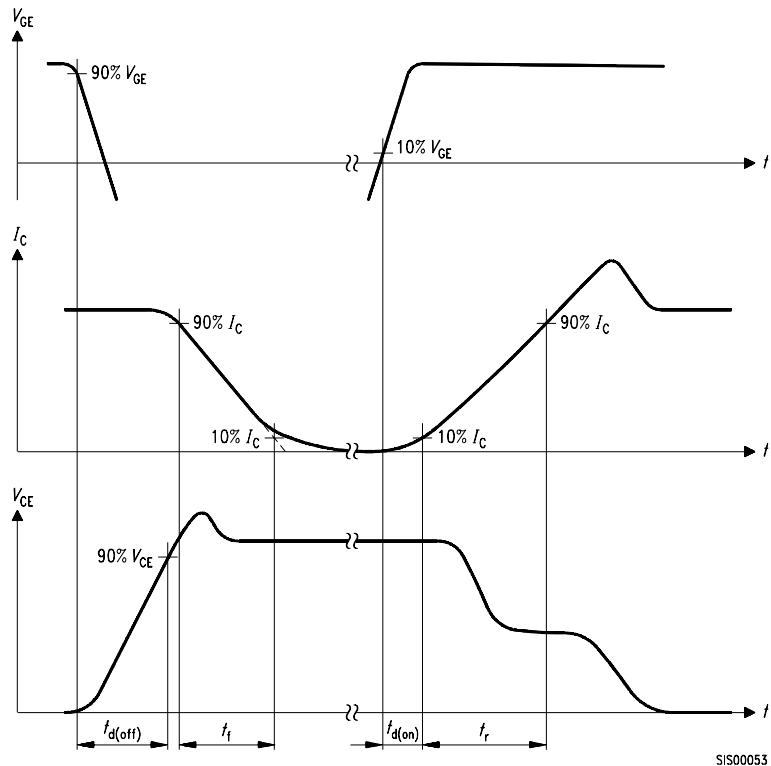
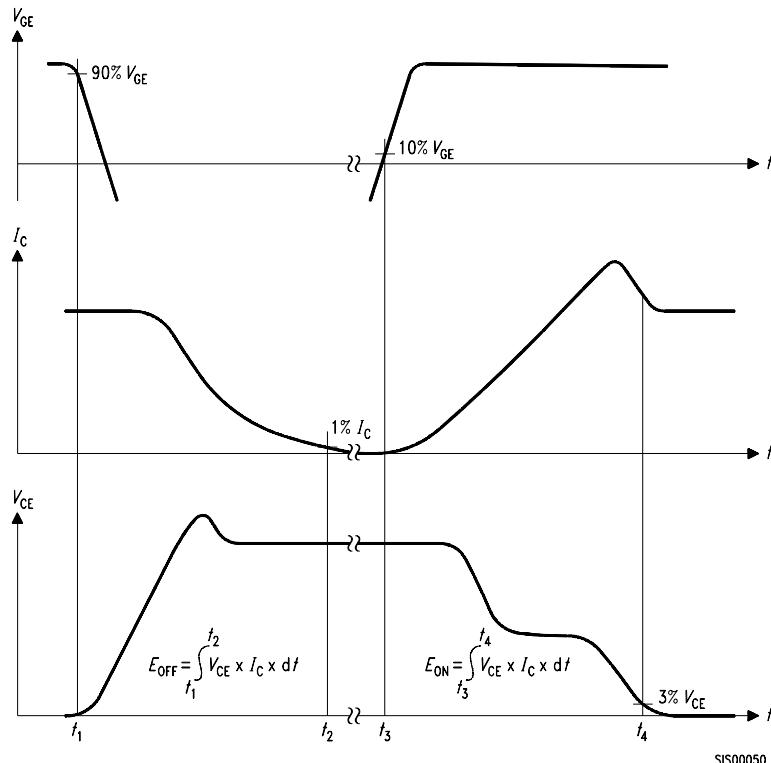
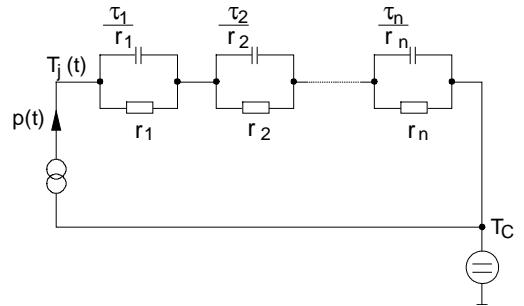
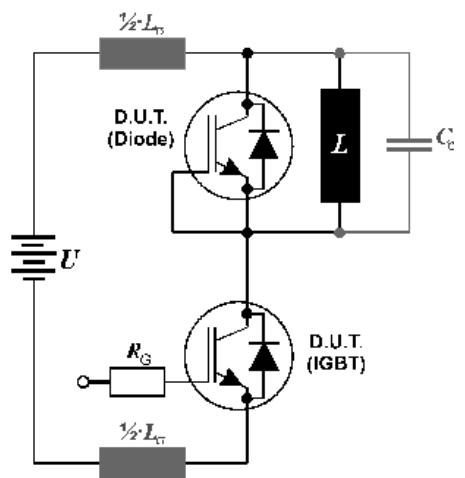
| symbol | dimensions |       |             |        |
|--------|------------|-------|-------------|--------|
|        | [mm]       |       | [inch]      |        |
|        | min        | max   | min         | max    |
| A      | 9.80       | 10.20 | 0.3858      | 0.4016 |
| B      | 0.70       | 1.30  | 0.0276      | 0.0512 |
| C      | 1.00       | 1.60  | 0.0394      | 0.0630 |
| D      | 1.03       | 1.07  | 0.0406      | 0.0421 |
| E      | 2.54 typ.  |       | 0.1 typ.    |        |
| F      | 0.65       | 0.85  | 0.0256      | 0.0335 |
| G      | 5.08 typ.  |       | 0.2 typ.    |        |
| H      | 4.30       | 4.50  | 0.1693      | 0.1772 |
| K      | 1.17       | 1.37  | 0.0461      | 0.0539 |
| L      | 9.05       | 9.45  | 0.3563      | 0.3720 |
| M      | 2.30       | 2.50  | 0.0906      | 0.0984 |
| N      | 15 typ.    |       | 0.5906 typ. |        |
| P      | 0.00       | 0.20  | 0.0000      | 0.0079 |
| Q      | 4.20       | 5.20  | 0.1654      | 0.2047 |
| R      | 8° max     |       | 8° max      |        |
| S      | 2.40       | 3.00  | 0.0945      | 0.1181 |
| T      | 0.40       | 0.60  | 0.0157      | 0.0236 |
| U      | 10.80      |       | 0.4252      |        |
| V      | 1.15       |       | 0.0453      |        |
| W      | 6.23       |       | 0.2453      |        |
| X      | 4.60       |       | 0.1811      |        |
| Y      | 9.40       |       | 0.3701      |        |
| Z      | 16.15      |       | 0.6358      |        |

**P-TO252 (D-Pak)**

**BACK VIEW**

| symbol | dimensions |        |          |          |
|--------|------------|--------|----------|----------|
|        | [mm]       |        | inch     |          |
|        | min        | max    | min      | max      |
| A      | 6.40       | 6.73   | 0.2520   | 0.2650   |
| B      | 5.25       | 5.50   | 0.2067   | 0.2165   |
| C      | (0.65)     | (1.15) | (0.0256) | (0.0453) |
| D      | 0.63       | 0.89   | 0.0248   | 0.0350   |
| E      | 2.28       |        | 0.2520   |          |
| F      | 2.19       | 2.39   | 0.0862   | 0.0941   |
| G      | 0.76       | 0.98   | 0.0299   | 0.0386   |
| H      | 0.90       | 1.21   | 0.0354   | 0.0476   |
| K      | 5.97       | 6.23   | 0.2350   | 0.2453   |
| L      | 9.40       | 10.40  | 0.3701   | 0.4094   |
| M      | 0.46       | 0.58   | 0.0181   | 0.0228   |
| N      | 0.87       | 1.15   | 0.0343   | 0.0453   |
| P      | 0.51       | -      | 0.0201   | -        |
| R      | 5.00       | -      | 0.1969   | -        |
| S      | 4.17       | -      | 0.1642   | -        |
| T      | 0.26       | 1.02   | 0.0102   | 0.0402   |
| U      | -          | -      | -        | -        |

**P-TO251 (I-Pak)**


| symbol | dimensions |      |             |        |
|--------|------------|------|-------------|--------|
|        | [mm]       |      | [inch]      |        |
|        | min        | max  | min         | max    |
| A      | 6.47       | 6.73 | 0.2547      | 0.2650 |
| B      | 5.25       | 5.41 | 0.2067      | 0.2130 |
| C      | 4.19       | 4.43 | 0.1650      | 0.1744 |
| D      | 0.63       | 0.89 | 0.0248      | 0.0350 |
| E      | 2.29 typ.  |      | 0.0902 typ. |        |
| F      | 2.18       | 2.39 | 0.0858      | 0.0941 |
| G      | 0.76       | 0.86 | 0.0299      | 0.0339 |
| H      | 1.01       | 1.11 | 0.0398      | 0.0437 |
| K      | 5.97       | 6.23 | 0.2350      | 0.2453 |
| L      | 9.14       | 9.65 | 0.3598      | 0.3799 |
| M      | 0.46       | 0.56 | 0.0181      | 0.0220 |
| N      | 0.98       | 1.15 | 0.0386      | 0.0453 |


**Figure A. Definition of switching times**

**Figure B. Definition of switching losses**

**Figure D. Thermal equivalent circuit**

**Figure E. Dynamic test circuit**  
 Leakage inductance  $L_\sigma = 180\text{nH}$   
 and Stray capacity  $C_\sigma = 180\text{pF}$ .



SGP02N60,

SGB02N60

SGD02N60

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**Published by**  
**Infineon Technologies AG,**  
**Bereich Kommunikation**  
**St.-Martin-Strasse 53,**  
**D-81541 München**  
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